# The RF Line

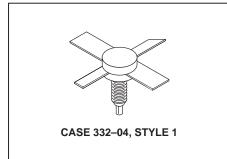
# **Microwave Pulse Power Transistor**

Designed for Class B and C common base amplifier applications in short pulse TACAN, IFF, and DME transmitters.

- Guaranteed Performance @ 1090 MHz, 50 Vdc Output Power = 90 Watts Peak Minimum Gain = 8.4 dB
- 100% Tested for Load Mismatch at All Phase Angles with 10:1 VSWR
- **Industry Standard Package**
- Nitride Passivated
- Gold Metallized for Long Life and Resistance to Metal Migration
- Internal Input Matching for Broadband Operation
- Circuit board photomaster available upon request by contacting RF Tactical Marketing in Phoenix, AZ.

# **MRF1090MA**

90 W PEAK, 960-1215 MHz **MICROWAVE POWER TRANSISTOR NPN SILICON** 



## **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Collector–Base Voltage	V <sub>CBO</sub>	70	Vdc
Emitter-Base Voltage	V <sub>EBO</sub>	4.0	Vdc
Collector-Current — Peak (1)	I <sub>C</sub>	6.0	Adc
Total Device Dissipation @ T <sub>C</sub> = 25°C (1) (2) Derate above 25°C	P <sub>D</sub>	290 1.66	Watts W/°C
Storage Temperature Range	T <sub>stg</sub>	-65 to +150	°C

## THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case (3)	$R_{ heta JC}$	0.6	°C/W

# **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS					
Collector–Emitter Breakdown Voltage $(I_C = 25 \text{ mAdc}, V_{BE} = 0)$	V <sub>(BR)CES</sub>	70	_	_	Vdc
Collector–Base Breakdown Voltage (I <sub>C</sub> = 25 mAdc, I <sub>E</sub> = 0)	V <sub>(BR)CBO</sub>	70	_	_	Vdc
Emitter–Base Breakdown Voltage ( $I_E = 5.0 \text{ mAdc}, I_C = 0$ )	V <sub>(BR)EBO</sub>	4.0	_	_	Vdc
Collector Cutoff Current $(V_{CB} = 50 \text{ Vdc}, I_E = 0)$	I <sub>CBO</sub>	_	_	5.0	mAdc

### **ON CHARACTERISTICS**

DC Current Gain (4)	h <sub>FE</sub>	10	30	_	_
$(I_C = 2.5 \text{ Adc}, V_{CE} = 5.0 \text{ Vdc})$					

# NOTES:

(continued)

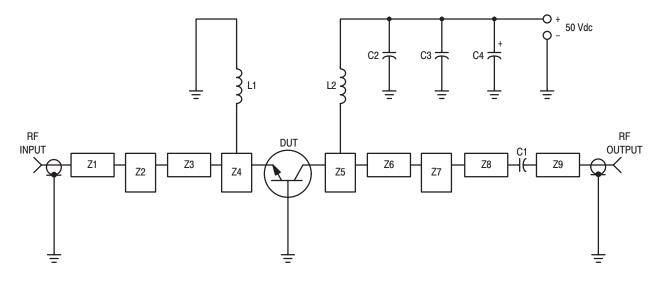
- 1. Pulse Width =  $10 \mu s$ , Duty Cycle = 1%.
- 2. This device is designed for RF operation. The total device dissipation rating applies only when the device is operated as an RF amplifier.
- 3. Thermal Resistance is determined under specified RF operating conditions by infrared measurement techniques.
- 4. 80 μs Pulse on Tektronix 576 or equivalent.

### REV 9



**ELECTRICAL CHARACTERISTICS** — **continued**  $(T_C = 25^{\circ}C)$  unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit	
DYNAMIC CHARACTERISTICS						
Output Capacitance (V <sub>CB</sub> = 50 Vdc, I <sub>E</sub> = 0, f = 1.0 MHz)	C <sub>ob</sub>	_	12	16	pF	
<b>FUNCTIONAL TESTS</b> (Pulse Width = 10 μs, Duty Cycle = 1.0%)	•	•	•	•	•	
Common–Base Amplifier Power Gain (V <sub>CC</sub> = 50 Vdc, P <sub>out</sub> = 90 W pk, f = 1090 MHz)	G <sub>PB</sub>	8.4	10.8	_	dB	
Collector Efficiency (V <sub>CC</sub> = 50 Vdc, P <sub>out</sub> = 90 W pk, f = 1090 MHz)	η	35	40	_	%	
Load Mismatch (V <sub>CC</sub> = 50 Vdc, P <sub>out</sub> = 90 W pk, f = 1090 MHz, VSWR = 10:1 All Phase Angles)	Ψ	No Degradation in Power Output				



C1, C2 — 220 pF Chip Capacitor, 100-mil ATC

 $\begin{array}{l} \text{C3} - 0.1 \; \mu\text{F} \\ \text{C4} - 47 \; \mu\text{F}/75 \; \text{V} \end{array}$ 

L1, L2 — 3 Turns #18 AWG, 1/8" ID

Z1-Z9 — Distributed Microstrip Elements,

See Photomaster

Board Material — 0.031" Thick Glass Teflon,  $\varepsilon_r$  = 2.5

Figure 1. 1090 MHz Test Circuit

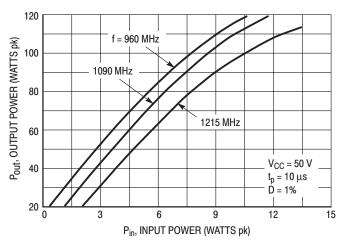


Figure 2. Output Power versus Input Power

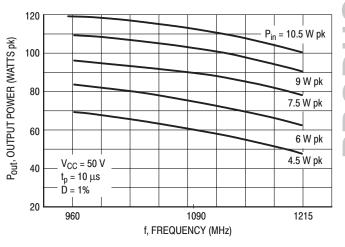
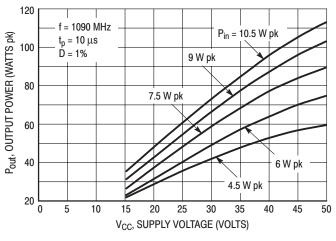


Figure 3. Output Power versus Frequency



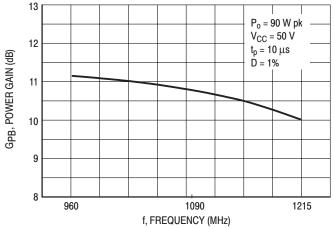
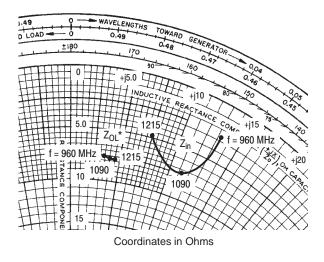


Figure 4. Output Power versus Supply Voltage

Figure 5. Power Gain versus Frequency



**ARCHIVE INFORMATION** 

 $P_{out} = 90 \text{ W pk}$   $V_{CC} = 50 \text{ V}$  $t_p = 10 \text{ \mu s}$  D = 1%

f	Z <sub>in</sub>	Z <sub>OL</sub> *
MHz	Ohms	Ohms
960	2.8 + j13.2	7.6 + j3.5
1090	7.4 + j11.4	7.6 + j4.0
1215	4.7 + j7.5	7.7 + j4.5

Z<sub>OL</sub>\* = Conjugate of the optimum load impedance into which the device output operates at a given output power, voltage, and frequency.

Figure 6. Series Equivalent Input/Output Impedance

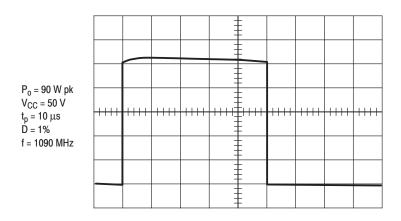
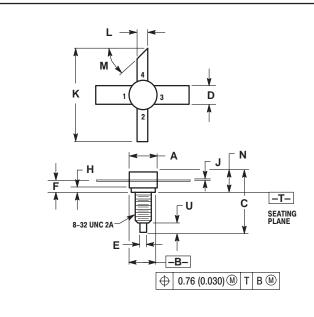


Figure 7. Typical Pulse Performance

MOTOROLA RF DEVICE DATA MRF1090MA

## PACKAGE DIMENSIONS



- 1. DIMENSION K APPLIES TWO PLACES. 2. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1973.

	MILLIN	IETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	6.86	7.62	0.270	0.300	
В	6.10	6.60	0.240	0.260	
С	16.26	16.76	0.640	0.660	
D	4.95	5.21	0.195	0.205	
Е	1.40	1.65	0.055	0.065	
F	2.67	4.32	0.105	0.170	
Н	1.40	1.65	0.055	0.065	
J	0.08	0.18	0.003	0.007	
K	15.24		0.600		
L	2.41	2.67	0.095	0.105	
М	45 °NOM		45 °	NOM	
N	4.97	6.22	0.180	0.245	
U	2.92	3.68	0.115	0.145	

STYLE 1:

PIN 1. BASE

2. EMITTER 3. BASE

COLLECTOR

**CASE 332-04 ISSUE D** 

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